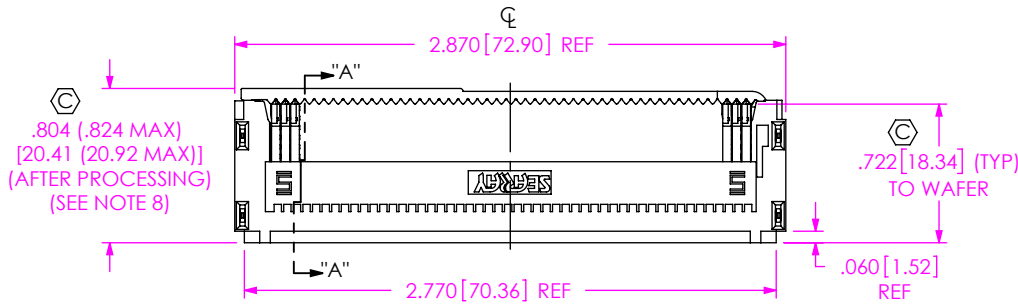


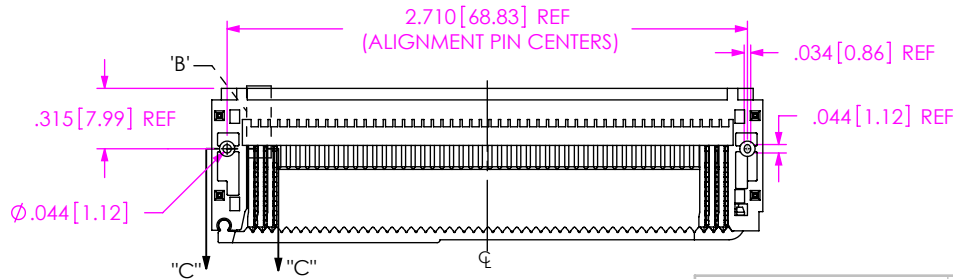
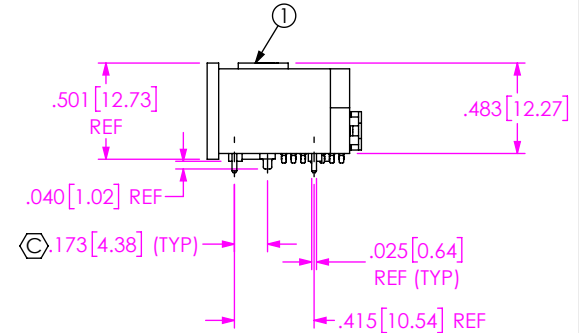
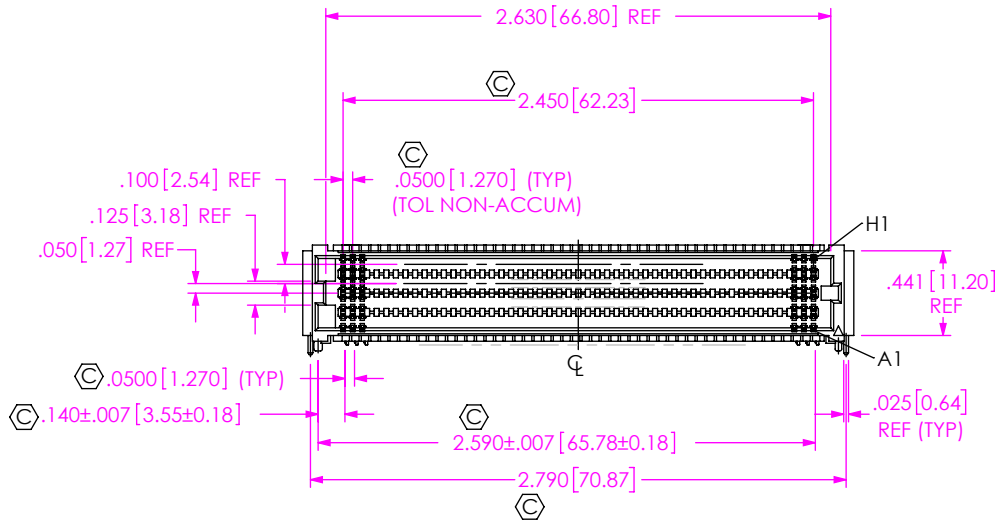
DO NOT SCALE FROM THIS PRINT



DO NOT UPDATE OR ADD REVISION WITHOUT APPROVAL THROUGH THE STANDARDS GROUP

NOTES:

1. VITA 74 CONNECTOR.
2. Ⓢ REPRESENTS A CRITICAL DIMENSION.
3. MINIMUM PUSH-OUT FORCE: .50 LBS[2.2N].
4. INSPECT DIMENSION AT 4 CORNERS OF PART.
5. FEATURE REQUIRED FOR VISION INSPECTION.
6. A 20~30°C TEMPERATURE DIFFERENCE MAY EXIST BETWEEN THIS HIGH-DENSITY COMPONENT AND THE BOARD SURFACE DURING REFLOW. SAMTEC RECOMMENDS A THERMAL STUDY BE PERFORMED
7. CHECK DIMENSION ON FIRST AND LAST ROW OF TAILS.
8. SOME RELAXATION/WARPING OF THE BACK STRAP IS ACCEPTABLE AFTER PROCESSING.
9. PARTS TO BE BULK LAYER FOAM TUBES TRAYS TAPE & REEL.
10. ORDERS WILL BE PACKAGED ACCORDING TO THE SAMTEC PACKAGING EFFICIENCY STANDARDS (SPES) FOUND ON WWW.SAMTEC.COM
11. ATTACH LABEL "SEAX-0001" TO EACH TAPE & REEL PACKAGE.



UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES.

TOLERANCES ARE:

DECIMALS ANGLES
 .XX: ±.01 [0.3] 2°
 .XXX: ±.005 [0.13]
 .XXXX: ±.0020 [0.051]

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520 PARK EAST BLVD, NEW ALBANY, IN 47150
 PHONE: 812-944-6733 FAX: 812-948-5047
 e-Mail: info@SAMTEC.com code 53322

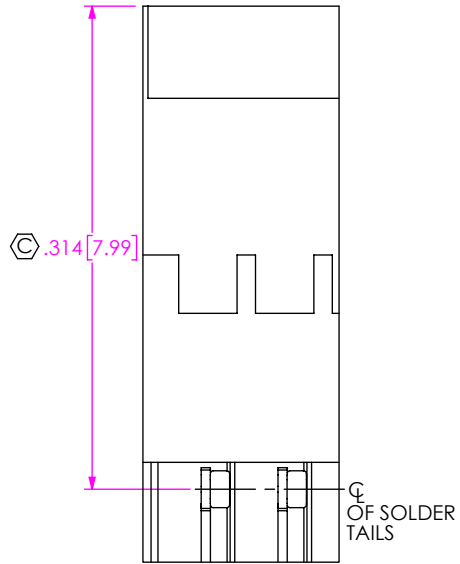
PLATING: DO NOT SCALE DRAWING SHEET SCALE: 1:1
 CONTACTS: CONTACT AREA: .000030 GOLD OVER .000050 NICKEL
 REMAINDER: .000200 REF TIN OVER .000050 NICKEL
 WELD TAB: ENTIRE PIN: .000200 REF TIN OVER .000050 NICKEL
 SOLDER COMPOSITION: 95.5% TIN / 3.8% SILVER / .7% COPPER CHARGE TAIL

DESCRIPTION: VITA 74 SEAF-RA (LEAD FREE)

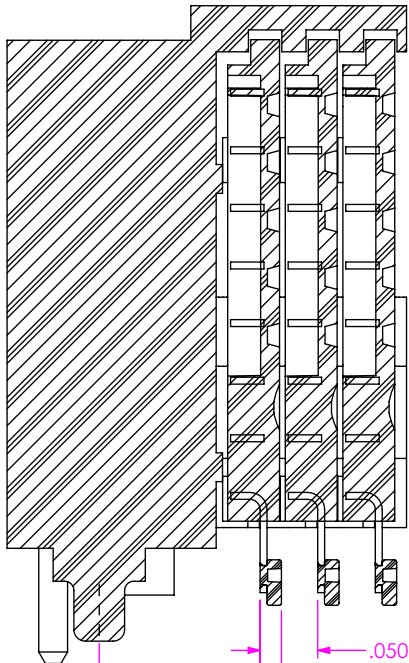
DWG. NO. ASP-161074-04

BY: J. BROWNING 09/22/2021 SHEET 1 OF 3

ITEM NO.	PART NO.	QUANTITY	MATERIAL
1	S-SEAF-50-01-L-08-2-RA-TR	1.0000	LCP, COLOR: BLACK/PHOS BRONZE/LEAD FREE SOLDER
2	CT-SEAF107MS	.01333	CONDUCTIVE POLYMER
3	SEAX-0001	1.0000	LABEL

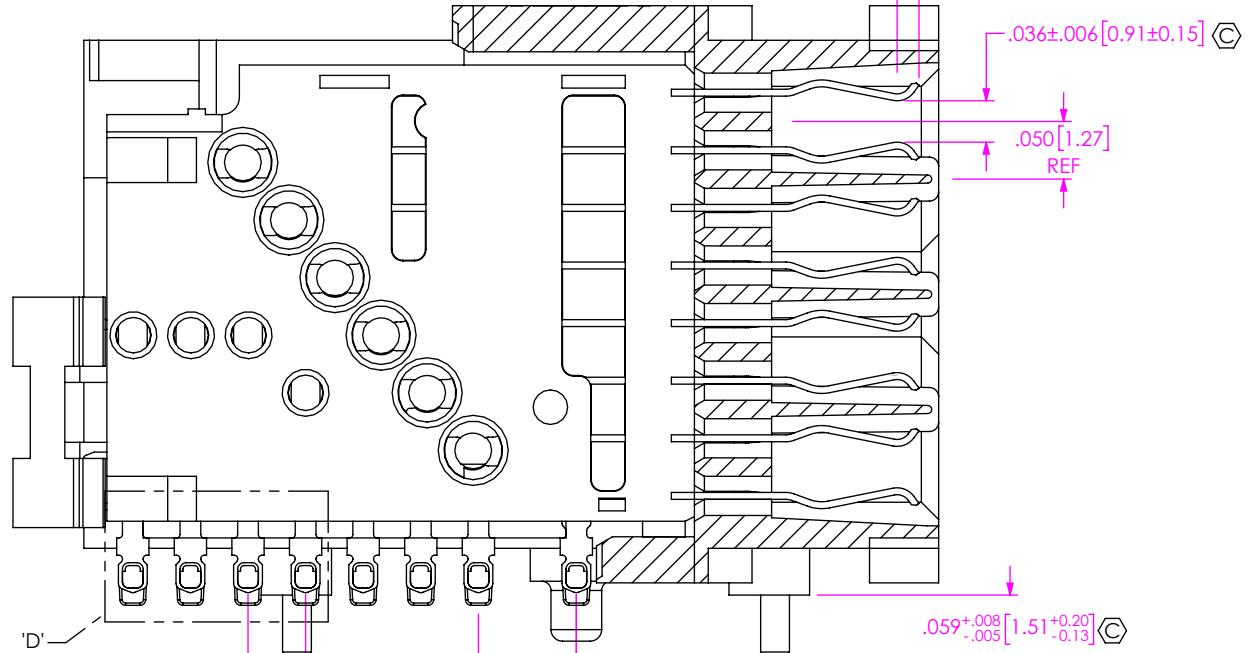


DETAIL 'B'
SCALE 8 : 1



SECTION "C"-"C"
SCALE 6 : 1

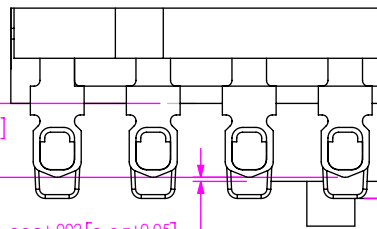
.140 [3.55] REF
.050 [1.27] (TYP)
.0185±.0030 [0.470±0.076] (TYP)



SECTION "A"-"A"
SCALE 6 : 1

.050 [1.27] (TYP)
.085 [2.16]
.172 [4.38]
.415 [10.54]
.059^{+0.008}_{-.005} [1.51^{+0.20}_{-0.13}] Ⓢ

.017 [0.43] REF
.036 [0.92] REF
.036±.006 [0.91±0.15] Ⓢ
.050 [1.27] REF



DETAIL 'D'
SCALE 10 : 1

.039 [0.98] REF
.002^{+0.002}_{-.003} [0.05^{+0.05}_{-0.03}] (SEE NOTE 4)
.009 [0.23] REF
.006 [0.15] Ⓢ

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DO NOT SCALE DRAWING

SHEET SCALE: 3:2

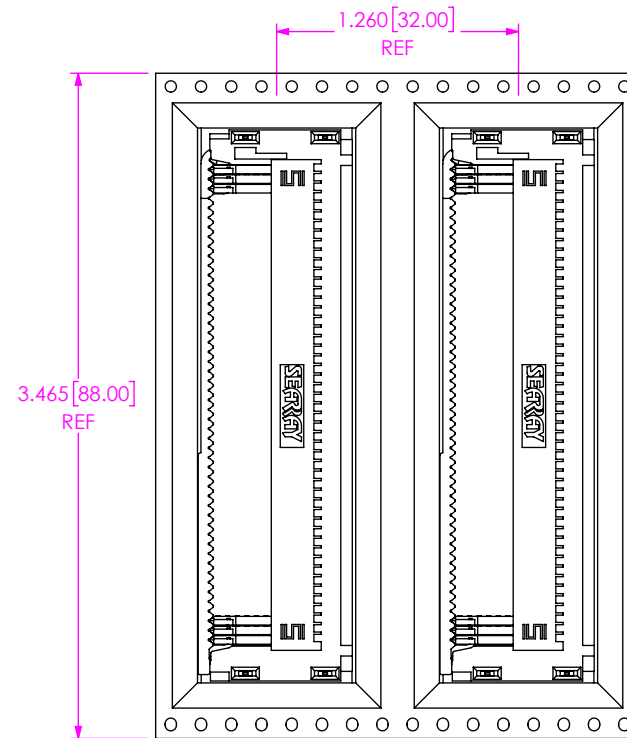
samtec

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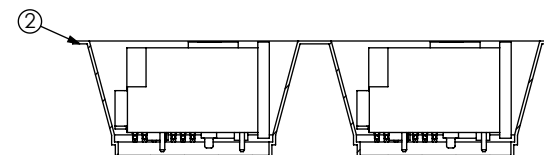
DESCRIPTION: VITA 74 SEAF-RA (LEAD FREE)

DWG. NO. ASP-161074-04

BY: J. BROWNING 09/22/2021 SHEET 2 OF 3



USER DIRECTION OF UN-REELING →
POCKET NOT DETAILED



PACKAGING VIEW

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e-Mail: info@SAMTEC.com code 55322

SHEET SCALE: 1:2

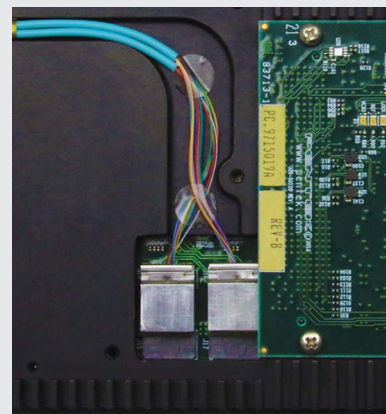
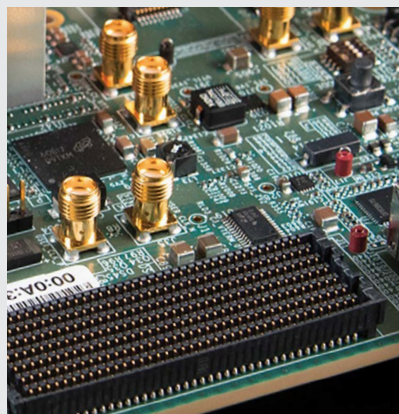
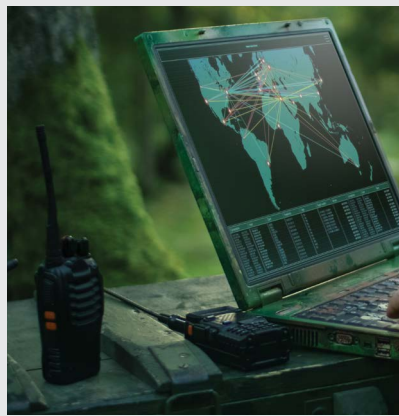
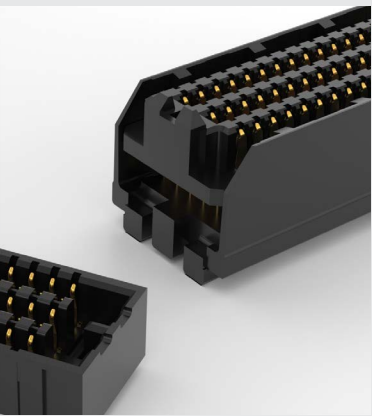
DESCRIPTION:
VITA 74 SEAF-RA (LEAD FREE)

DWG. NO.
ASP-161074-04

BY: J. BROWNING 09/22/2021 SHEET 3 OF 3



SOSA ALIGNED INTERCONNECT SOLUTIONS



HIGH-PERFORMANCE SOLUTIONS FOR SENSOR OPEN SYSTEMS ARCHITECTURE



INTERCONNECT SOLUTIONS

FOR SENSOR OPEN SYSTEMS ARCHITECTURE (SOSA)

SOSA defines an architecture and standards to support all Department of Defense (DoD) branches by creating interoperable sensor modules. Samtec is an active member of the SOSA Consortium, delivering **Sudden Service® solutions** that help **enable rapid, affordable, cross-platform connectivity for military/defense applications.**

The SOSA Standard defines a set of logical modules that group functions, behaviors, and interfaces, which together define the logical architecture of a sensor. Many of these modules are connected using **Samtec high-performance interconnects, which provide the flexibility, modularity, size, weight and power demands of current and future SOSA-based technologies.**



BENEFITS OF THE SOSA STANDARD

Reduce Development Cycle Time and Cost

Reduce Systems Integration Cost and Risk

Increase Commonality and Reuse

Enable Technology Transition

Facilitate Interoperability

Isolate the Effects of Change

Reduce Sustainment Modernization Cost

Support Capability Evolution

Mitigate Obsolescence

INDUSTRY APPLICATIONS

Communications (Comms)

Electro-Optical/Infra-Red (EO/IR)

Electronic Warfare (EW)

Radar

Signals Intelligence (SIGINT) Systems

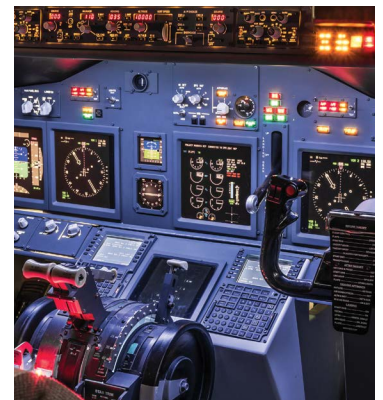


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SOSA Plug-In Cards (PICs) Using VNX

VITA 74 VNX SEARAY™
The Expanding VNX™ Ecosystem

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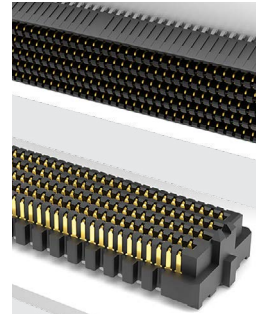
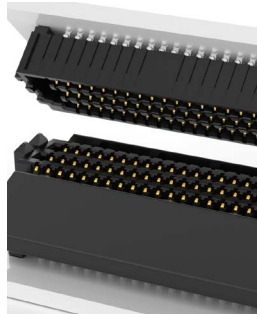
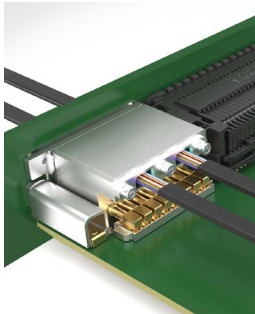
SOSA Plug-In Cards (PICs) Using OpenVPX

VITA 42 XMC & VITA 88 XMC+ Connectors
VITA 42, VITA 57.1/57.4 Precision Board Stacking Standoff
VITA 57.1 FMC & 57.4 FMC+ Connectors
VITA Optics



PRODUCT SOLUTIONS

Small Form Factor (SFF) • Rugged Designs • High-Speed • High-Reliability • High-Density



SMALL FORM FACTOR (SFF) DESIGNS

Samtec is a leader in ruggedized Small Form Factor (SFF) solutions, with modular systems designed to incorporate flexible mixed signaling requirements.

Our focus on SFF designs also means we are mindful of the Size, Weight and Power (SWaP) impact.

HARDWARE PLUG-IN CARD (PICs) STANDARDS

VITA 42 XMC specifies Samtec's SamArray® connectors, which provide mezzanine expansion and customization capabilities for SOSA™ PICs using OpenVPX™.

VITA 74 VNX provides high-speed capabilities, rugged design and small form factors for SOSA PICs using VNX.

SEVERE ENVIRONMENT TESTING

SET-qualified products have been tested beyond typical industry standards for performance confidence in rugged military, aerospace and defense applications. For additional details, please visit samtec.com/SET.

RUGGED SOLUTIONS

Commercial-off-the-Shelf (COTS), Application-Specific Products (ASP) & Military/Aerospace (MAP) interconnect solutions are available with a variety of rugged features to ensure quality and durability in any application.

HIGH-SPEED PERFORMANCE

Samtec delivers **Sudden Service**® solutions via a broad line of high-speed, high-density interconnect systems that provide extreme design flexibility, as well as durability and reliability in harsh environments.

SOSA PICs USING VNX

VITA 74 VNX introduces a new approach to rugged Small Form Factor (SFF) design. A unique module-based format provides system architects greater freedom in developing COTS SFF systems, with a machined chassis, robust backplane and conduction-cooled modules that unite for an extremely rugged assembly.



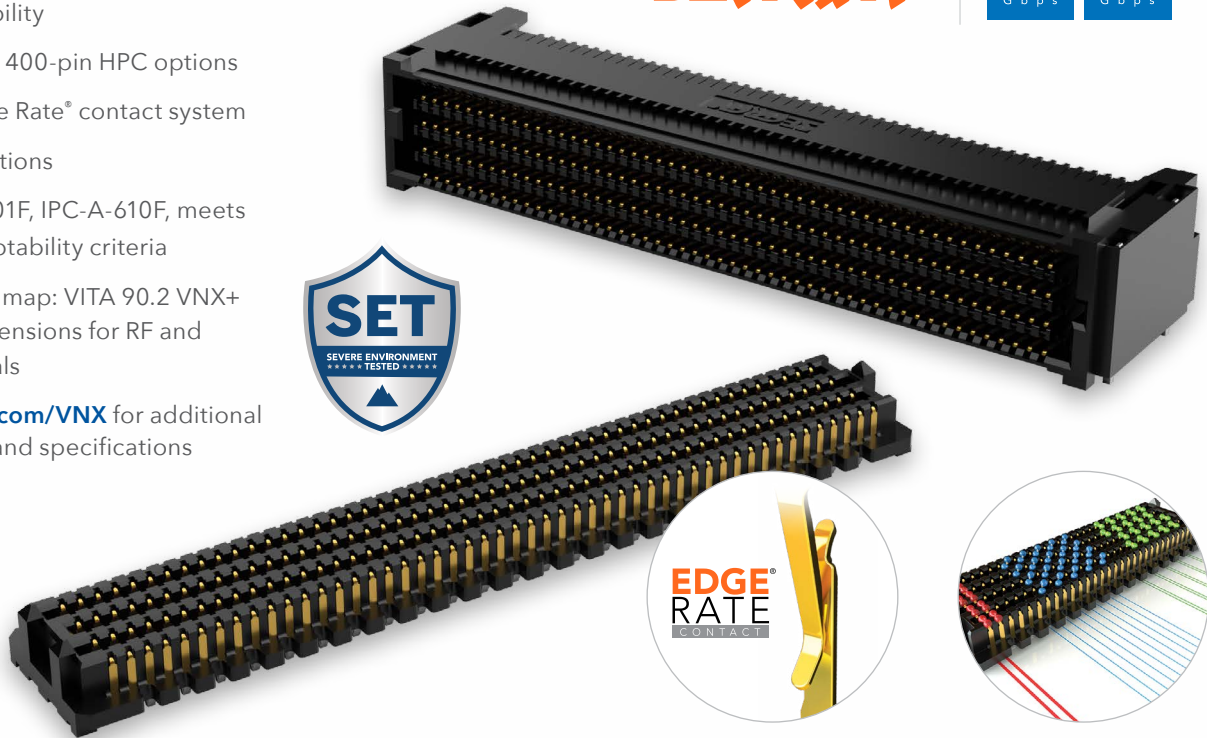
VITA 74 VNX SEARAY™ HIGH-DENSITY OPEN-PIN-FIELD ARRAYS

VITA 74 VNX specifies high-density Samtec's SEARAY™ Right-Angle connectors for 19 mm stack heights. SEARAY™ was chosen for its high-speed capabilities and rugged design.

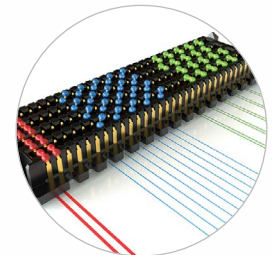
- Ideal for Hardware Plug-in Card Profiles (PICPs) in 19mm VNX cards
- 1.27 mm pitch open-pin-field array with maximum grounding and routing flexibility
- 240, 320 and 400-pin HPC options
- Rugged Edge Rate® contact system
- Lead-free options
- IPC J-STD-001F, IPC-A-610F, meets Class 3 acceptability criteria
- Product roadmap: VITA 90.2 VNX+ Standard extensions for RF and Optical signals
- Visit samtec.com/VNX for additional information and specifications

SEARAY™

NRZ	PAM4
28 Gbps	56 Gbps



Signal Integrity Optimized Rugged Edge Rate® Contacts



Open-Pin-Field Design for Routing Flexibility

Standard	Samtec Product	Connectors			Options			
		Part No.	12.5 mm Mated (LPC 200 Pin)	19 mm Mated (HPC 400 Pin)	Solder Ball Type	Alignment Pins	Tape & Reel	Plating
VITA 74 VNX™	SEARAY™	ASP-161073-03	Male	–	Lead-Free	✓	✓	10 μ" Gold
		ASP-161074-03	Female	–				
		ASP-161073-04	–	Male				
		ASP-161074-04	–	Female				

THE EXPANDING VNX ECOSYSTEM

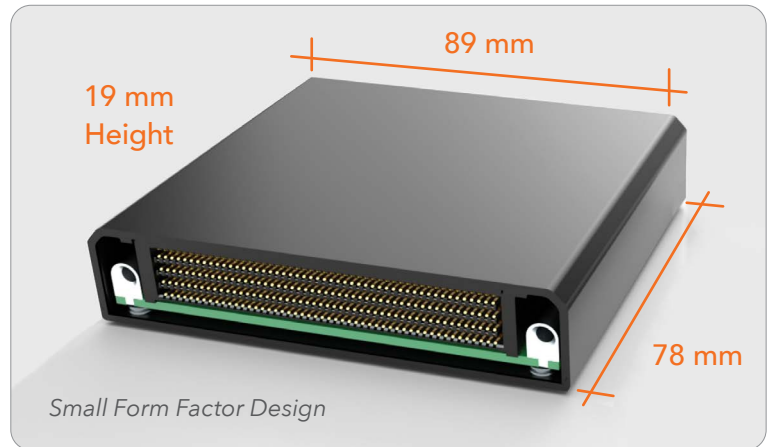
The embedded marketplace continues to drive SWaP (Size, Weight and Power) requirements to the extreme. Many of these demands call for high performance but at a much-reduced size and power.

VITA 74 standard-based products serve markets that require rugged performance, as well as data plane interconnect technologies that closely follow the industry's state-of-the-art.



Various vendors are already incorporating these VNX technologies offering features such as:

- Small Form Factor (SFF) switched serial interconnects
- Open-frame backplane design
- Legacy I/O compatibility at the Plug-In Module level



APPLICATION: TRIDENT INFOSOL RAPTOR VITA 74 VNX COTS COMPUTER

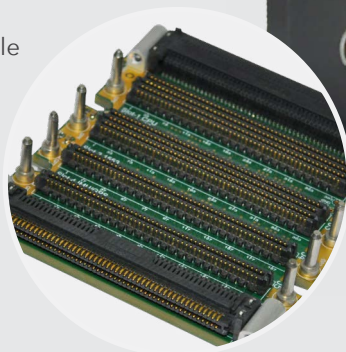
The Raptor is a rugged, small form factor, Commercial Off the Shelf (COTS), pre-qualified computer based on VNX standard. VNX is the continued evolution of the VPX standard specifically designed for significantly smaller deployments.

Additional Features:

- Small Form Factor Modular Design
- Extended operating temperatures (-40 °C to +71 °C Continuous)
- EMI compliance per MIL-STD-461F
- PCIe® 3.0 compliance

Featured Samtec Products:

- VITA 74 VNX (12.5 mm Lead-Free) 200-Pin I/O Male Connector (SEARAY™ ASP-161073-01)
- VITA 74 VNX (12.5 mm Lead-Free) 200-Pin I/O Female Connector (SEARAY™ Right-Angle ASP-161074-01)
- VITA 74 VNX (19 mm Lead-Free) 400-Pin I/O Female Connector (SEARAY™ ASP-161073-02)
- VITA 74 VNX (19 mm Lead-Free) 400-Pin I/O Female Connector (SEARAY™ Right-Angle ASP-161074-02)



samtec.com/vnx

SOSA PICs USING OpenVPX

VITA 42 XMC is a widely deployed mezzanine standard used in high-reliability computers implementing switched-fabric architectures. VITA 42 XMC provides mezzanine expansion and customization capabilities for SOSA™ PICs using VITA 65 OpenVPX™.



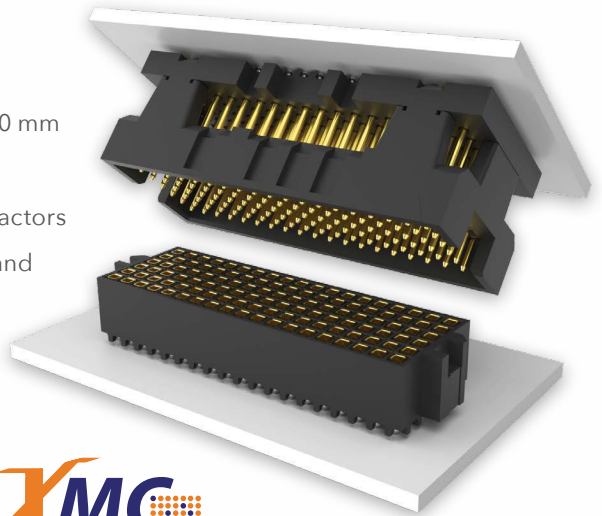
VITA 42 XMC™ SamArray® HIGH-DENSITY OPEN-PIN-FIELD ARRAYS

VITA 42 XMC specifies solder ball-equipped SamArray® connectors in 10 mm and 12 mm stack heights supporting PCIe® 4.0 performance.

- Ideal for Hardware Plug-in Card Profiles (PICPs) in 6U & 3U VPX form factors
- .050" (1.27 mm) pitch open-pin-field array with maximum grounding and routing flexibility
- 10 mm and 12 mm board stack heights available
- 114-pin (6 x 19) options
- Lead-free and tin-lead options
- Optional pick and place pad and tape and reel packaging



Visit samtec.com/XMC for additional information.

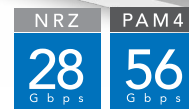
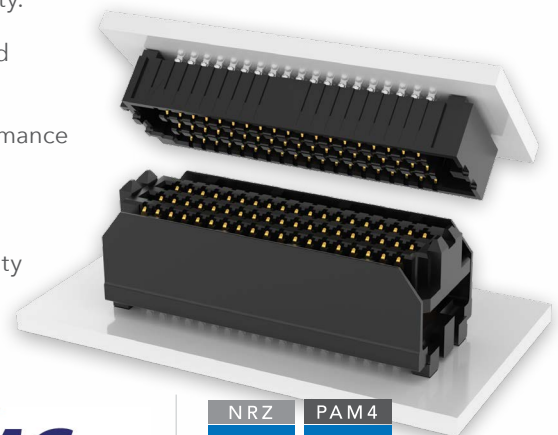


VITA 88 XMC+ SEARAY™ HIGH-DENSITY OPEN-PIN-FIELD ARRAYS

VITA 88 XMC+ defines an alternative connector backwards compatible with VITA 42 electrical footprints. This allows designers to improve existing VITA 42 and/or VITA 61 designs by swapping connectors. The result is superior Signal Integrity (PCIe® 5.0 and 100 GbE operation) and improved mechanical performance and durability.

- Solder to existing VITA 42/VITA 61 electrical footprints, providing backward compatibility in most applications
- Elevated terminal and standard socket connectors improve channel performance and follow traditional XMC geometry
- Robust housing features protect contacts from stubbing or bent pins
- Rated at 1,000 cycles, the VITA 88 contact system increases mating durability over VITA 42/VITA 61, both rated at 500 cycles
- IPC Class 3 compliant solder charges available in both tin-lead and lead-free RoHS versions
- Available in 10 mm, 12 mm, 16 mm and 18 mm stack heights

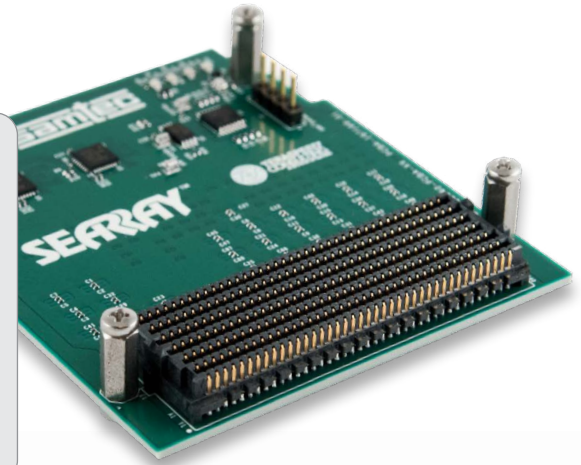
Visit samtec.com/XMC-plus for additional information.



VITA 42, VITA 57.1/57.4 MICRO JACK SCREW PRECISION BOARD STACKING STANDOFF

Optional standoffs reduce risk of damage when unmating mezzanine cards.

- Designated for PCI/104-Express®, VITA 42, 57.1 and 57.4 systems for use with SamArray® and SEARAY™ connectors
- Divides PCBs in a steady, even motion to reduce risk of component damage
- Works as a traditional standoff
- Available with or without thread locker
- 10 mm and 12 mm board stack heights
- M2.5, M3, and #4-40 threads available
- Operates with a 1.5 mm Allen key or driver
- Visit samtec.com/xmc for a full list of JSOM Series configurations



VITA 57.1 FMC & 57.4 FMC+ CONNECTORS

SEARAY™ Open-Pin-Field Arrays in 10 mm & 12 mm Stack Heights.

- VITA 57.1 FMC: 68 Single-Ended or 34 Differential Pairs (LPC), or 160 Single-Ended or 80 Differential Pairs (HPC)
- VITA 57.4 FMC+ with 560 pins in a 14 x 40 array (HSPC) and an optional extension connector for 80 additional positions in a 4 x 20 array



Visit samtec.com/VITA for full details and specifications.

VITA OPTICS

Extended Temp FireFly™ Optical Micro Flyover System™

- Lane speeds of 10 Gbps and 25 Gbps
- Size, Weight and Power (SWAP) optimized
- Operational temperature range of -40 °C to +85 °C
- Shock and vibration per MIL-STD 810G, relative humidity to 95% non-condensing
- Option for secure firmware
- Multiple connector options including MT38999, MT, MTP®, MXC®, and VITA 66.X



Visit samtec.com/FireFly for full details and specifications.

GLOBAL MANUFACTURING & SUPPORT



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SUDDEN SERVICE®